

# Pixelated Resistive Micromegas for High-Rate Environment

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on behalf of RHUM R&D project group:

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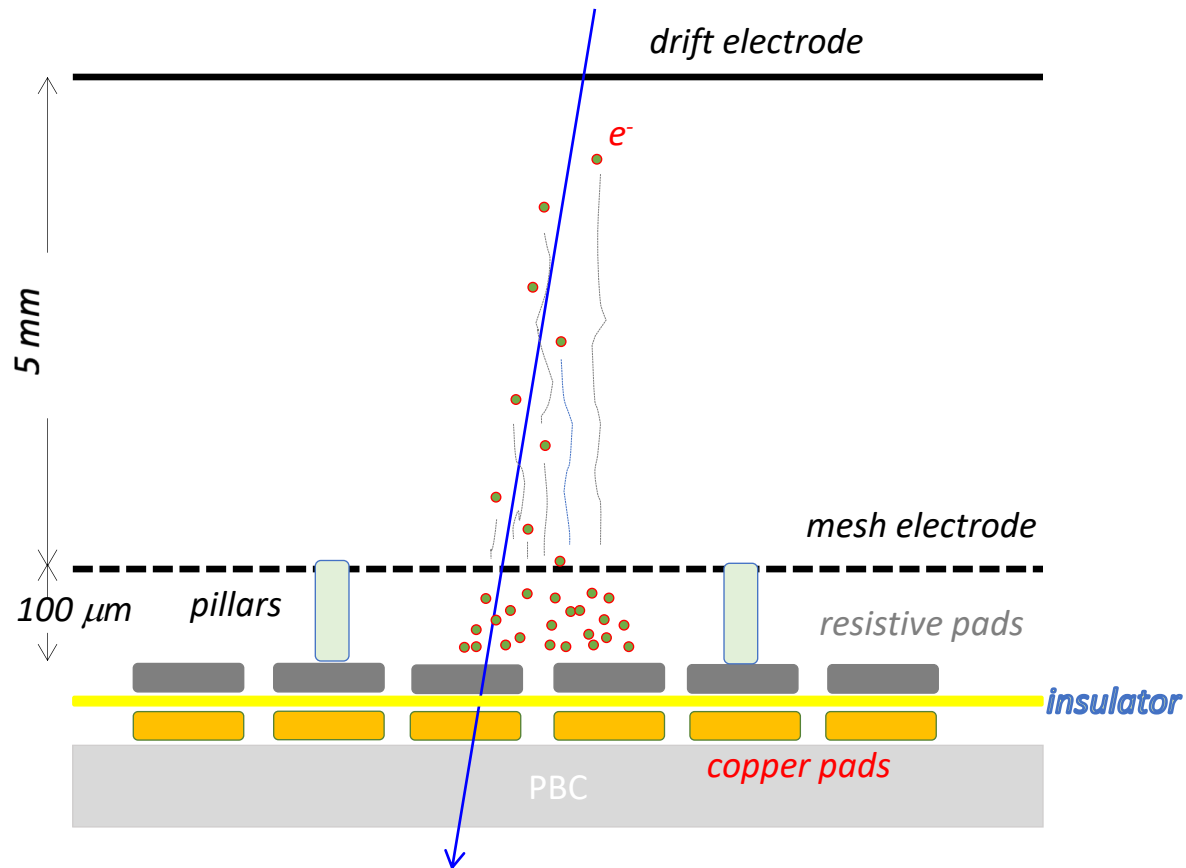
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# Small Pads Resistive Micromegas

## Conceptual scheme:

Resistive MicroMeGas technology consists in 'covering' the copper 'small' anode pads,  $O(\text{mm}^2)$ , with a resistive 'structure' (for ex. pads as in figure) to suppress discharges



## Main purpose:

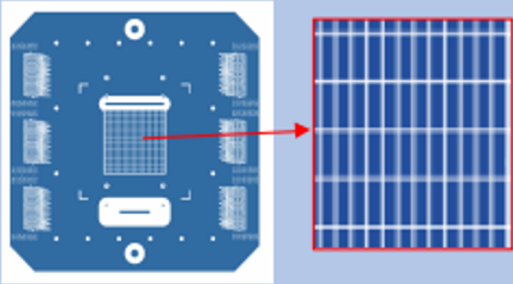
get a tracking detector operating at very high rate  $\sim 10 \text{ MHz/cm}^2$

## through:

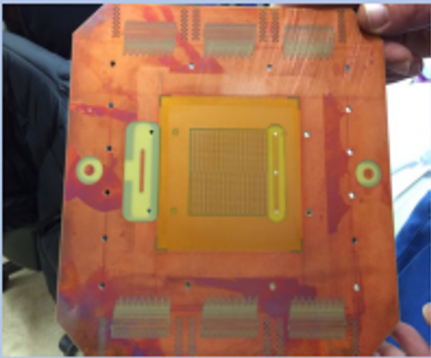
- fine readout granularity, to reduce occupancy;
- optimization of the spark resistive protection, to have stability of operation at high rates/gains;
- demonstration of the scalability of the detector to large surfaces;
- simplification of the construction technique for industrial production

# Prototypes and their Spark Resistive Protection Layouts

Readout PAD anodic plane  
(common to all prototypes)



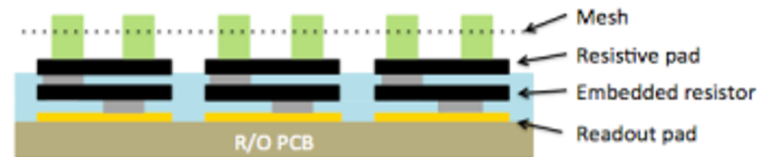
4.8 x 4.8 cm<sup>2</sup> active region  
768 pads, 0.8 x 2.8 mm<sup>2</sup> each  
48 pads - 1 mm pitch ("x")  
16 pads - 3 mm pitch ("y")



Signals routed to six  
Panasonic connectors

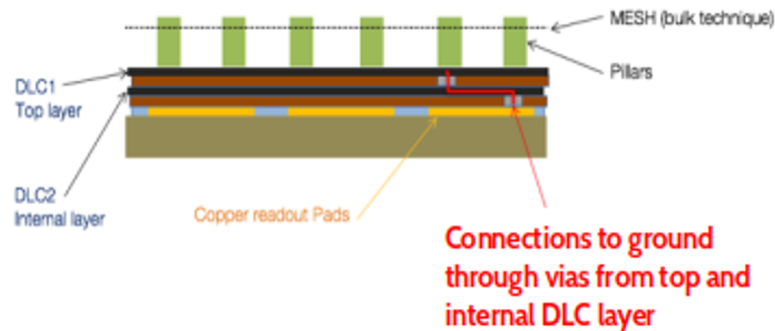
CONFIGURATIONS of the resistive layers  
two main categories: Pad-patterned and uniform DLC layers

## PAD-Patterned



- Two planes of independent resistive pads with the same geometry of the copper readout pads
- New technique based on etched DLC layer for the intermediate embedded resistor

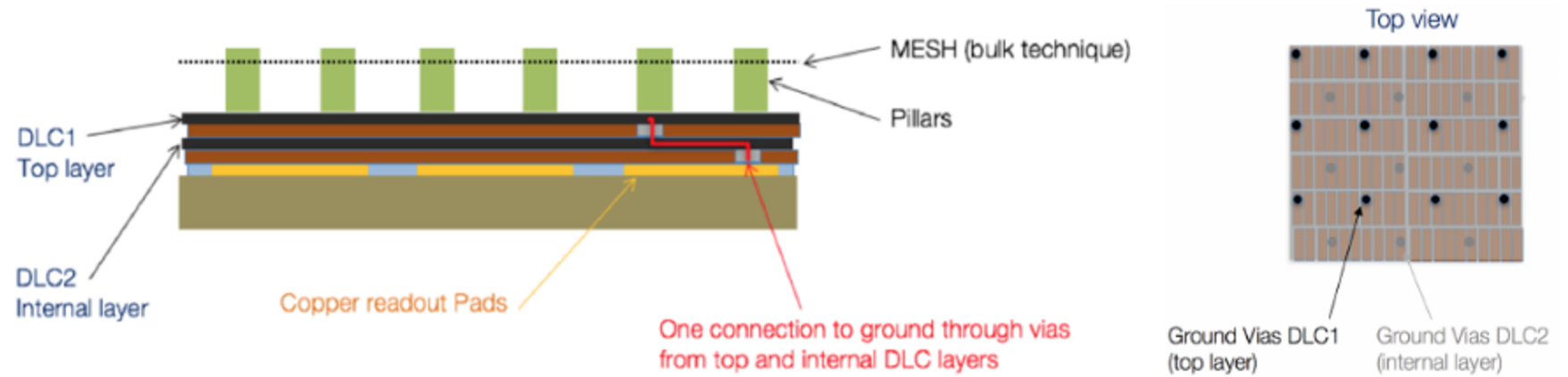
## Uniform Double DLC



- Uniform double DLC layers with grounding connections
- Sequential Build-Up technique (based on copper-clad DLC) implemented in recent years
- Grounding vias either DOT or STRIP

# The DOT and STRIP versions of the DLC type

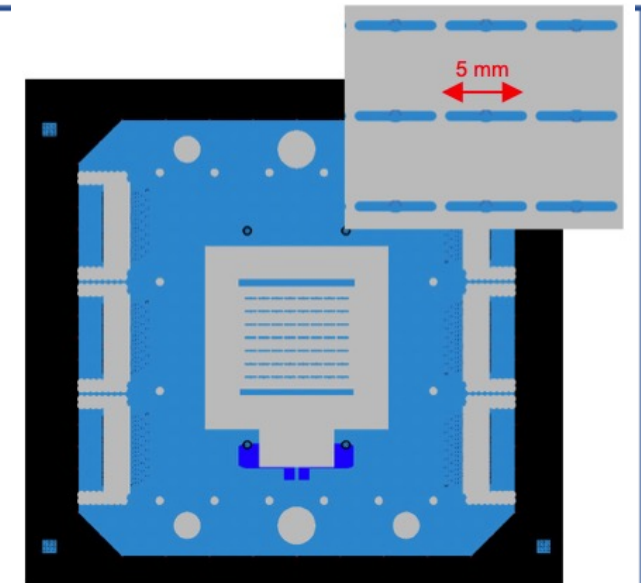
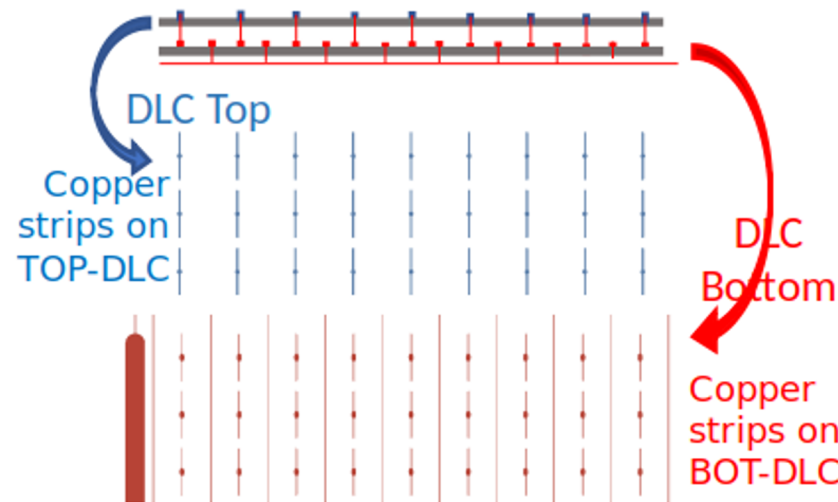
## Double DLC "Standard" DOT version



## Double DLC new "Strip" version

by Rui De Oliveira

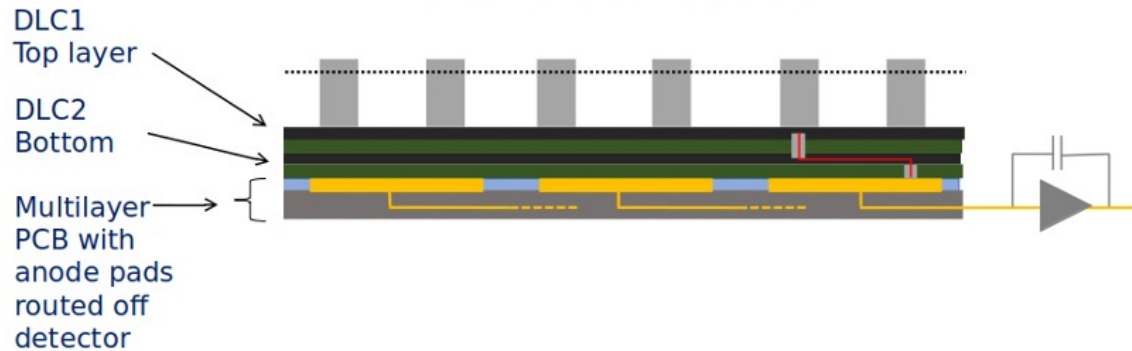
- Mix of standard DLC-SBU and Silver-Grid (SG) used in uRWell
- **Main goal: keep separate sectors with grounding boundaries to avoid any dependence on the irradiated surface**
- Drawback → longer pillars → smaller active area



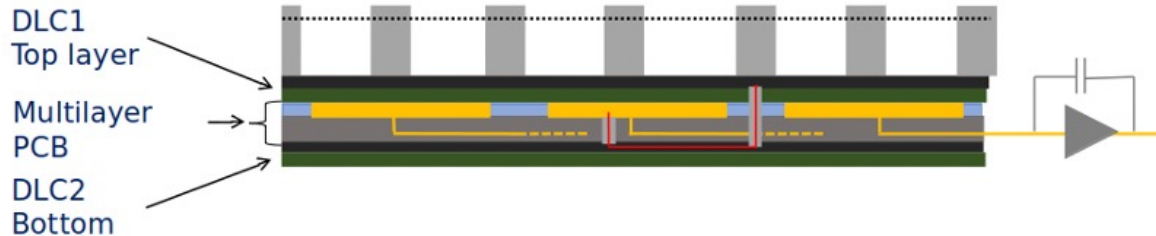


## Other variation on the Uniform Double DLC Layout

### Standard layout



### New layout



Read-out pads (in yellow in the figures), normally placed under the two resistive DLC foils.

In the new layout they are in between them →

- capacitance increase to collect a larger fraction of the signal

## Summary of the Small-Pads MM Prototypes

### Pad-Patterned (PAD-P3)

Resistance from top resistive pad to anode pad:  
15-25 M $\Omega$

Independent PADs, limited or negligible charge spread

### Standard DLC (DLC20)

Resistivity: Top and Bottom foils  $\sim 20$  M $\Omega/\square$

Grounding vias every 6 mm (12 mm) in the left (right) half of the detector

Read-out pads below the resistive DLC foils

**DLC-SBU (SBU3)** [Sequential Build-Up technique exploiting copper clad DLC]

Resistivity: Top  $22 \pm 1$  M $\Omega/\square$  - Bottom  $42 \pm 8$  M $\Omega/\square$

Readout pads between the resistive DLC foils

**DLC-SG** [Strip Grid grounding scheme]

Resistivity: Top  $40 \pm 2$  M $\Omega/\square$  - Bottom  $38 \pm 6$  M $\Omega/\square$

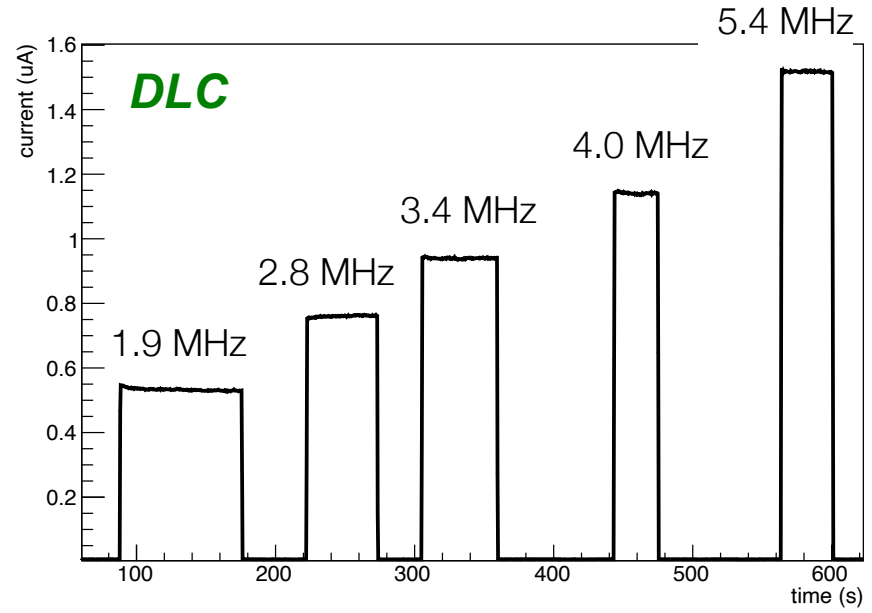
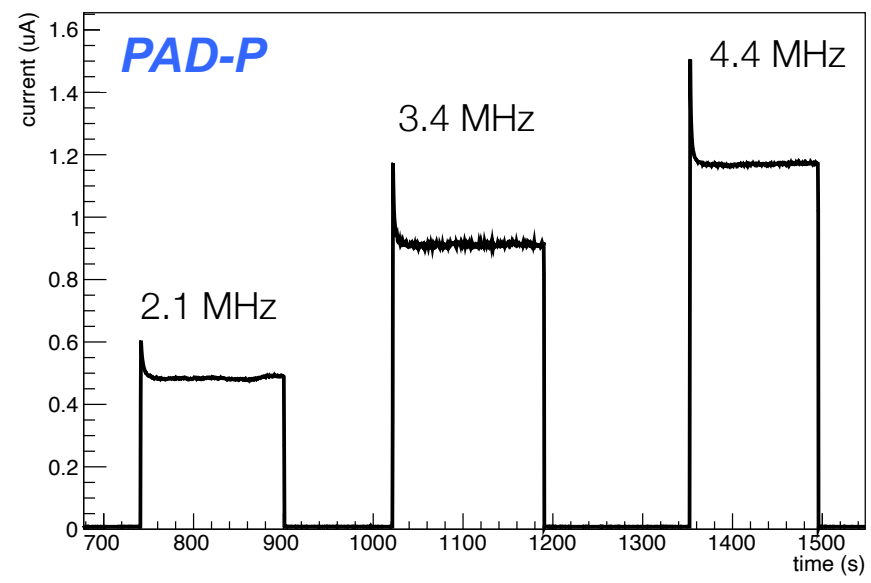
Readout pads between the resistive DLC foils

Longer pillars to cover the grounding copper strips

# Tests with X-Rays: charging up

- PAD-P types show a decrease of the current/gain ( $\sim 25\%$ ) when the X-Ray gun is switched on
- a possible explanation is the charging up of the dielectric (kapton) among pads, with a consequent reduction of the electric field

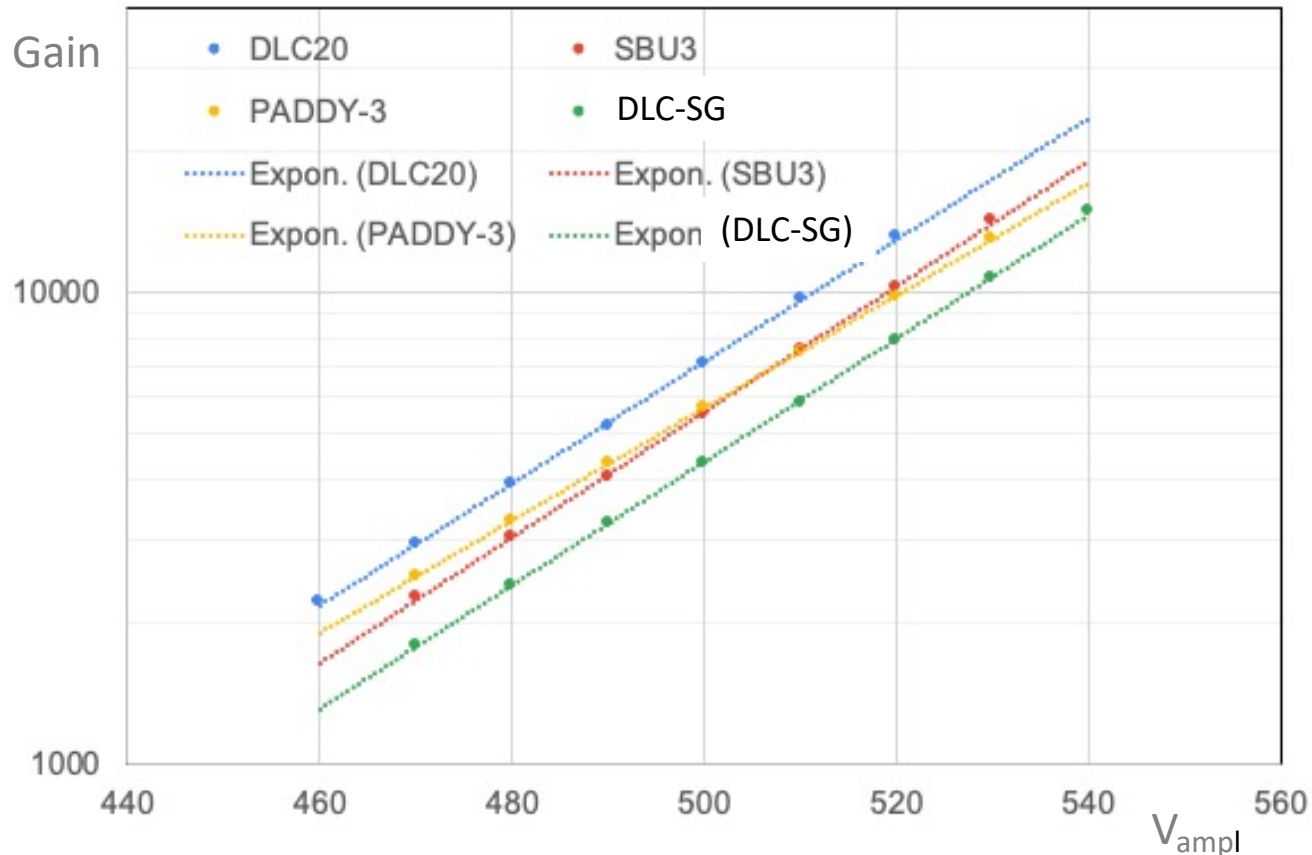
- DLC types do not show any sizeable charging-up effects (less than few %)
- infact their surface is uniformly resistive and has almost no dielectric, apart from pillars...



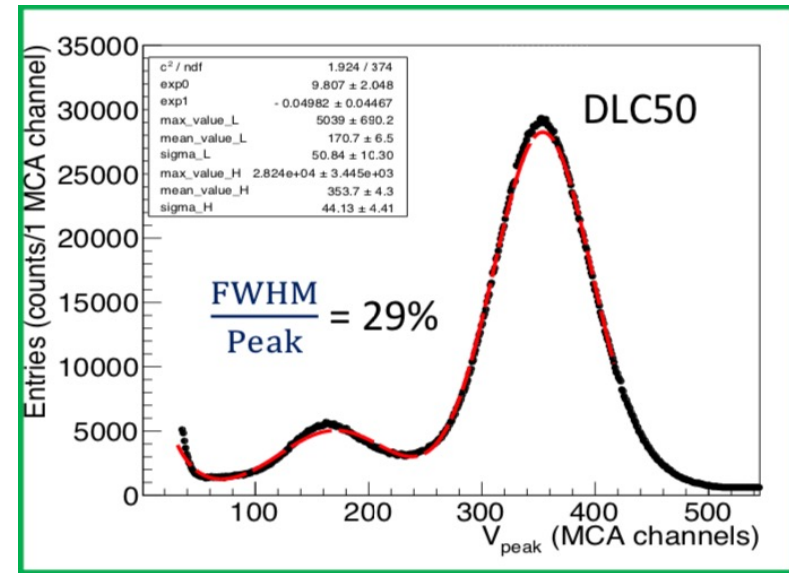
Current measurement vs Time during cycles of X-Rays irradiation

# Tests with $^{55}\text{Fe}$ source: GAIN

GAIN Vs HV from MCA\_Peak\_position



- Gas mixture Ar:CO<sub>2</sub>=93:7
- $^{55}\text{Fe}$  source rate  $\sim 20\text{kHz}$



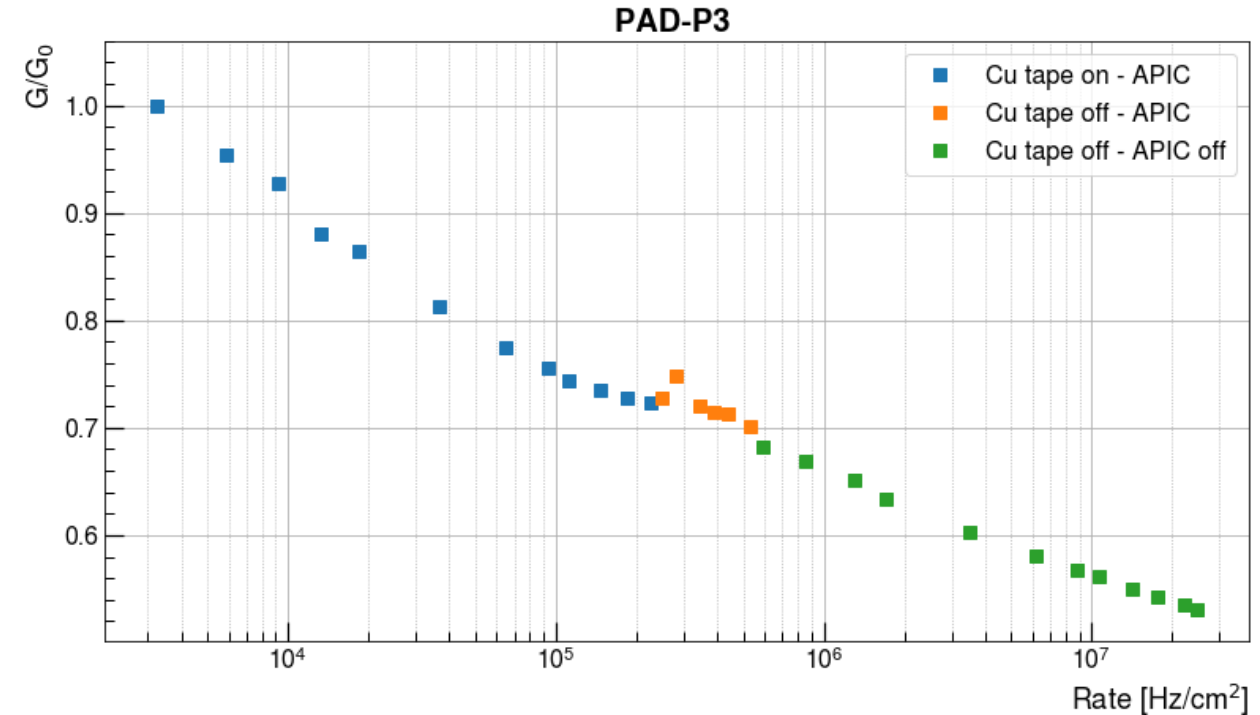
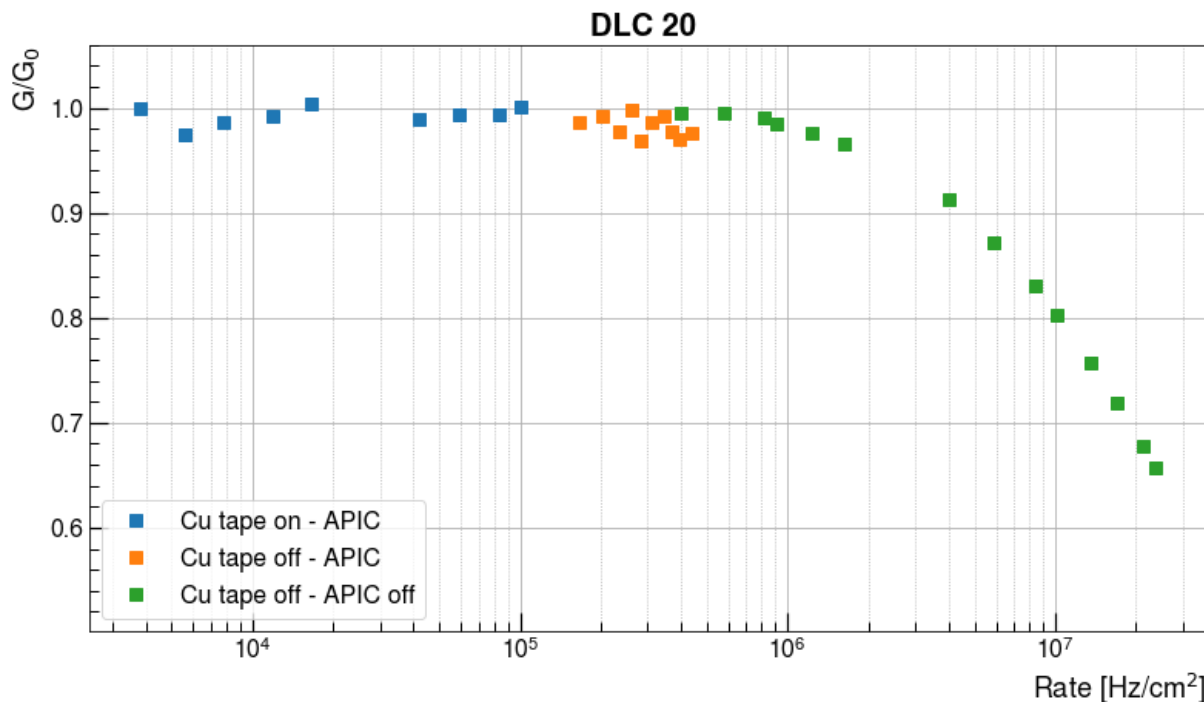
Energy resolution for DLC-type generally better than for PAD-P type

- Lower gain of PAD-P type with respect to DLC observed for all prototypes
- Different slope of PAD-P3 possibly due to an increase of charging-up with the gain
- Translations in the gain curves could be due to small differences in the amplification gap height

# High rates with X-Rays

## PAD-P scheme:

- 'fast' gain drop at "low" rates ( $<0.1\text{MHz/cm}^2$ ) due to charging-up
- 'slower' ohmic voltage drop through the individual pads from  $0.1\text{MHz/cm}^2$  on... (depending on pad resistivity value)



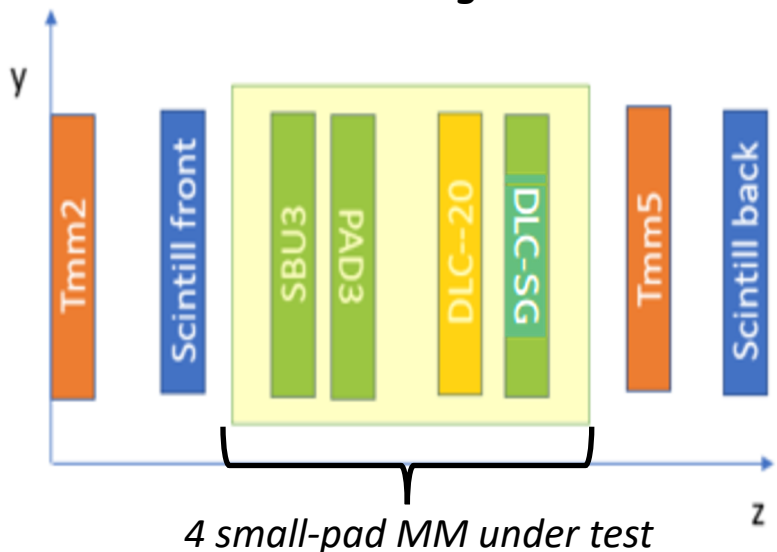
## DLC and SBU series:

- stable gain up to  $1\text{MHz/cm}^2$
- significant ohmic voltage drop at higher rates (depending on DLC resistivity value)

# Detector Efficiency

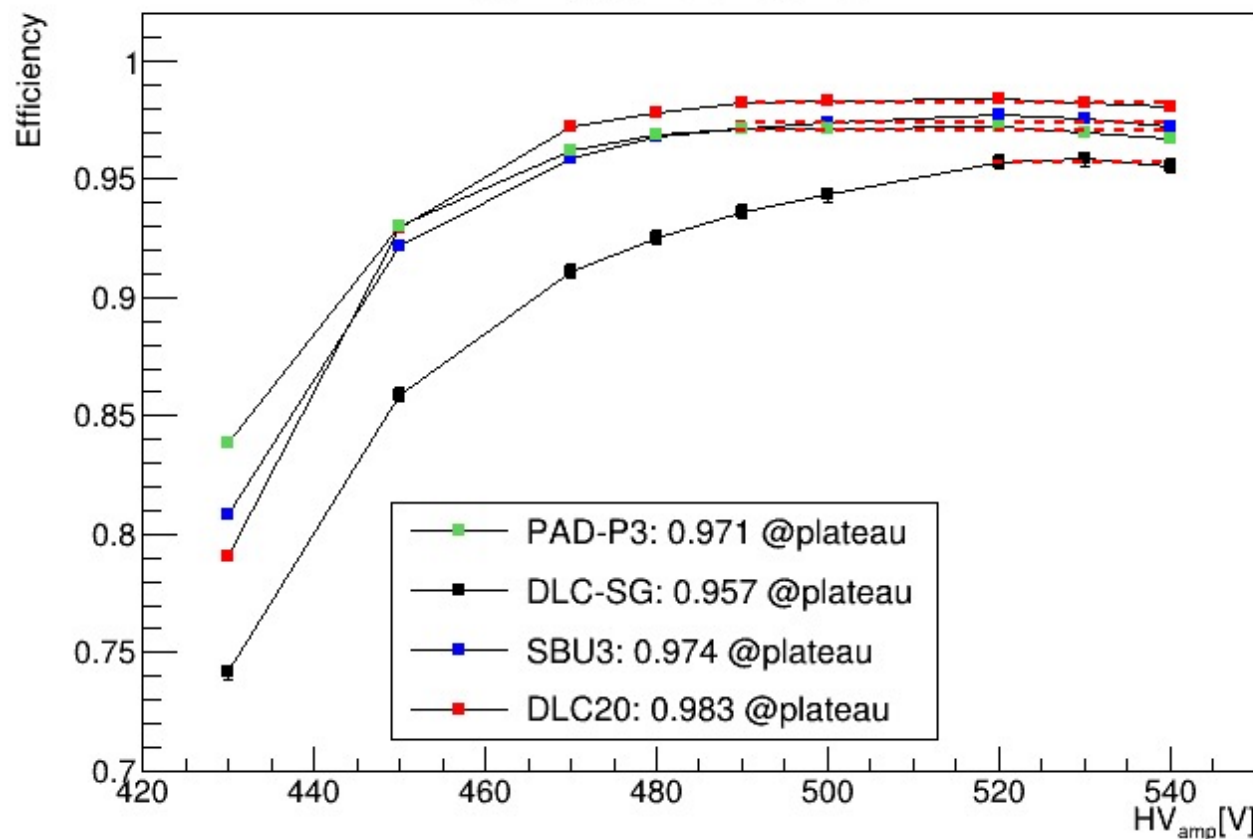
@ test beam

- Muon beam
- Ar:CO<sub>2</sub>=93:7 gas mixture



- efficiency measured through external tracking in the two TMM(2,5) (2D strip micromegas)
- Tracking efficiency: clusters are required to be within 1.5 mm from the extrapolated track position in the precision coordinate

Tracking efficiency vs. HV



For most of the prototypes: **detector efficiency > 97%**

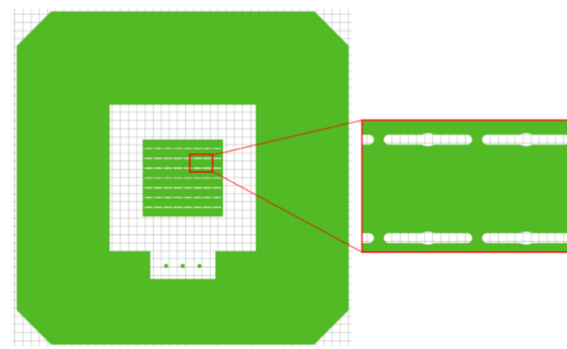
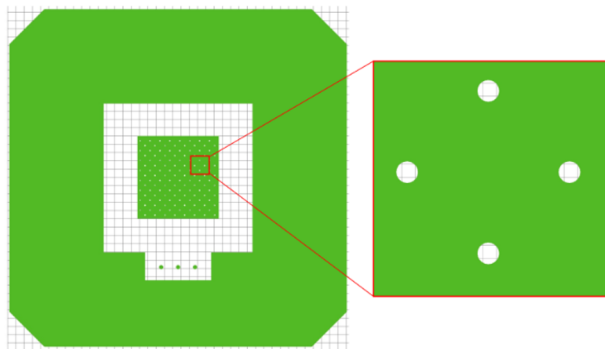
only for DLC-SG is ~1% less, due to the larger size of the pillars



# Detector Efficiency

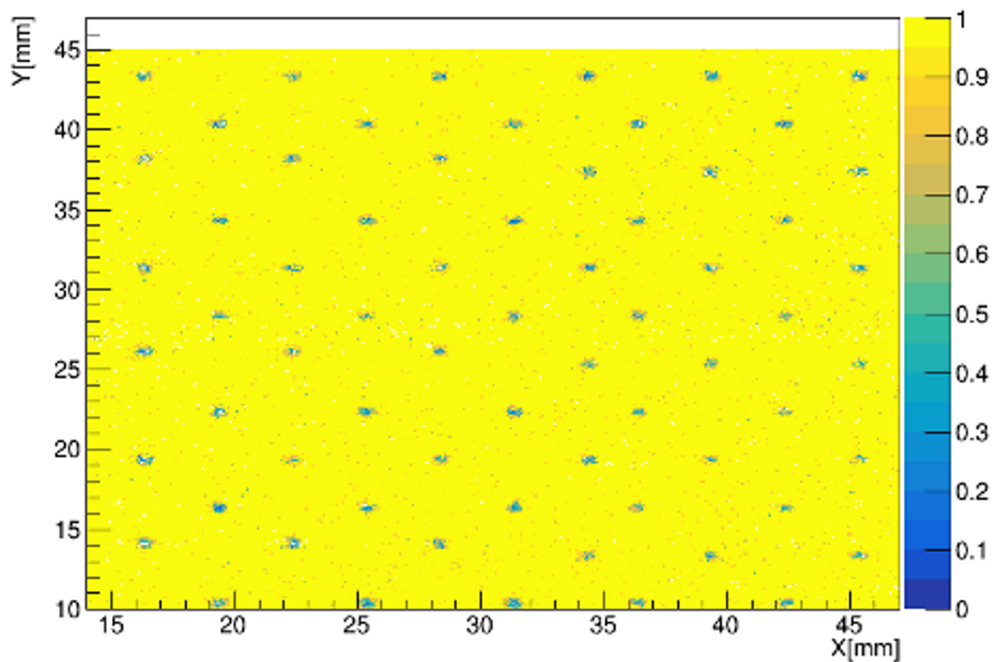
- Pillars observed as local inefficiency regions:

Circular pillars  
0.8 mm diameter  
**2.8% geometrical coverage**

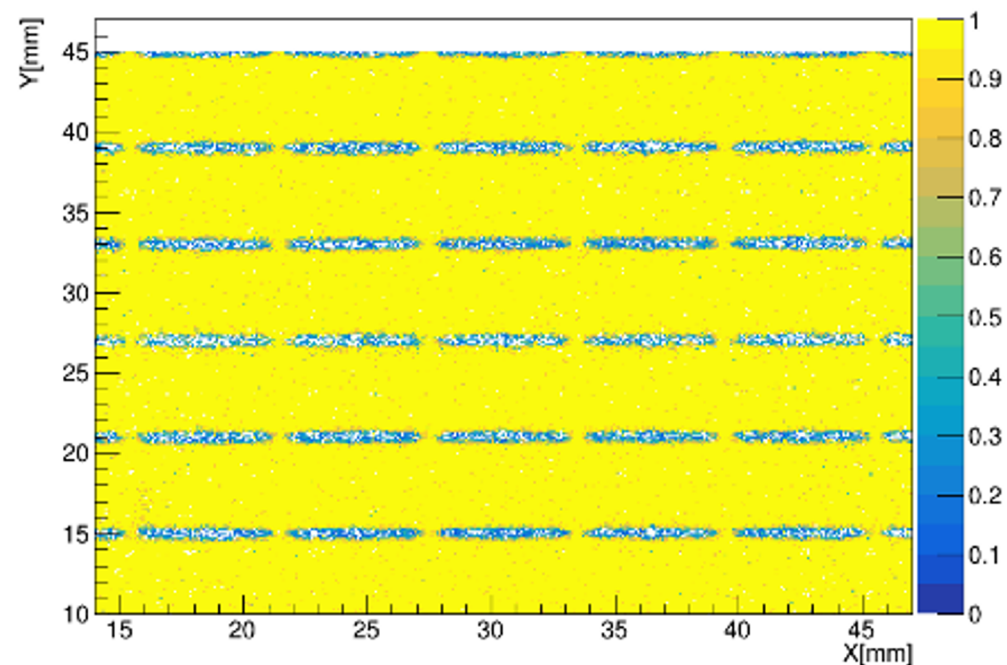


Elongated pillars (5.30 mm)  
for DLC-SG prototype  
**7.7% geometrical coverage**

cluster efficiency DLC-20



cluster efficiency DLC-SG

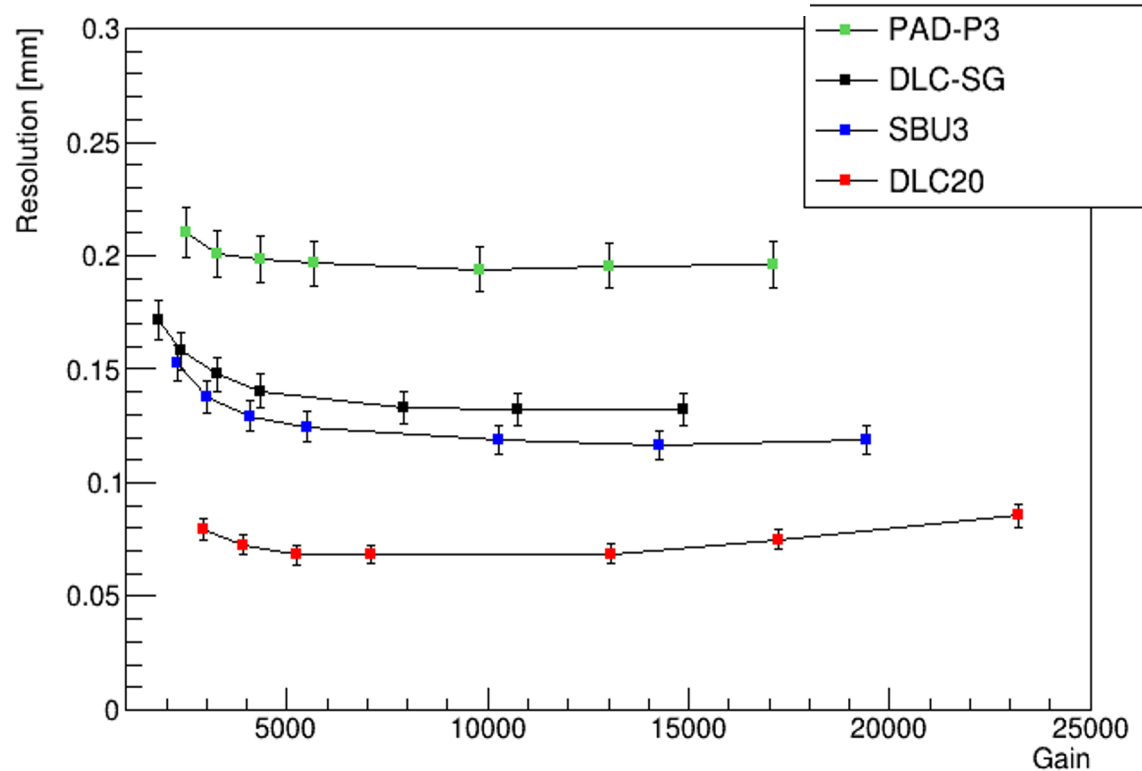




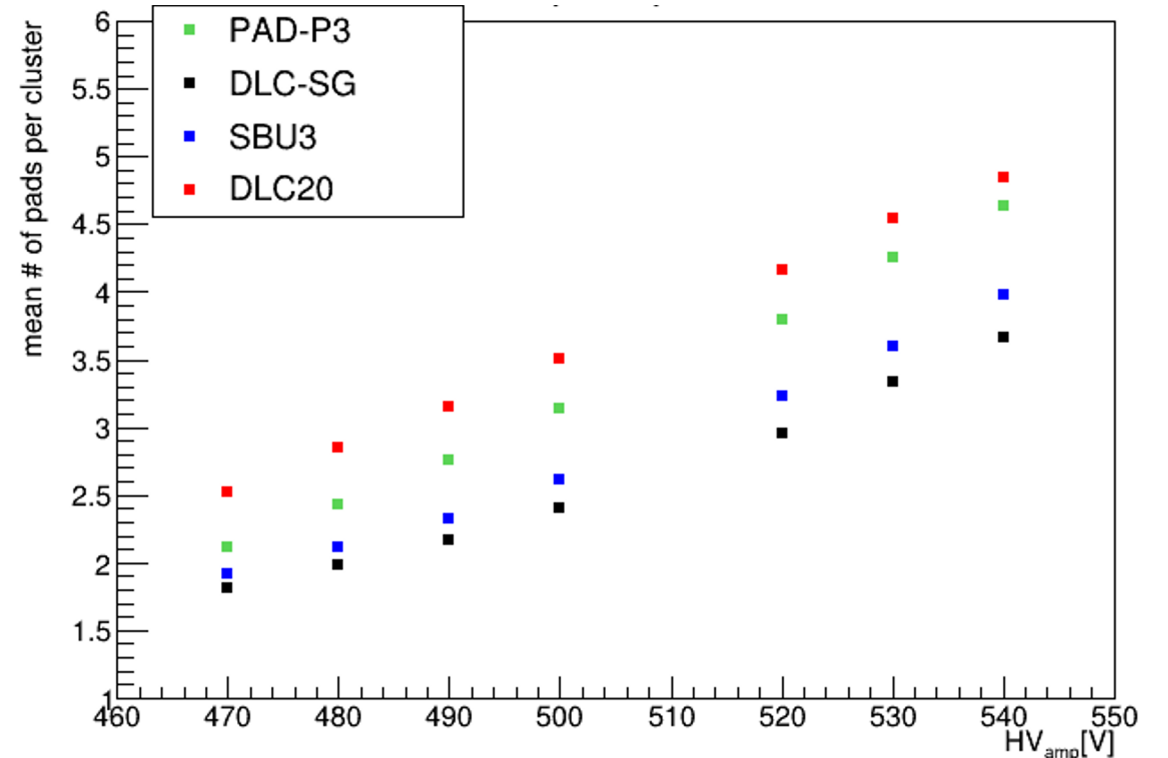
# Position Resolution

- position in every detector calculated from the charge weighted pad positions (cluster centroid)
- resolution obtained fitting the residual distribution in the precision coordinate w.r.t. TMM tracks (extrapolation error  $\sim 50 \mu\text{m}$ , subtracted in quadrature)

## Position resolution vs Gain:



## Mean number of pads per cluster vs HV:

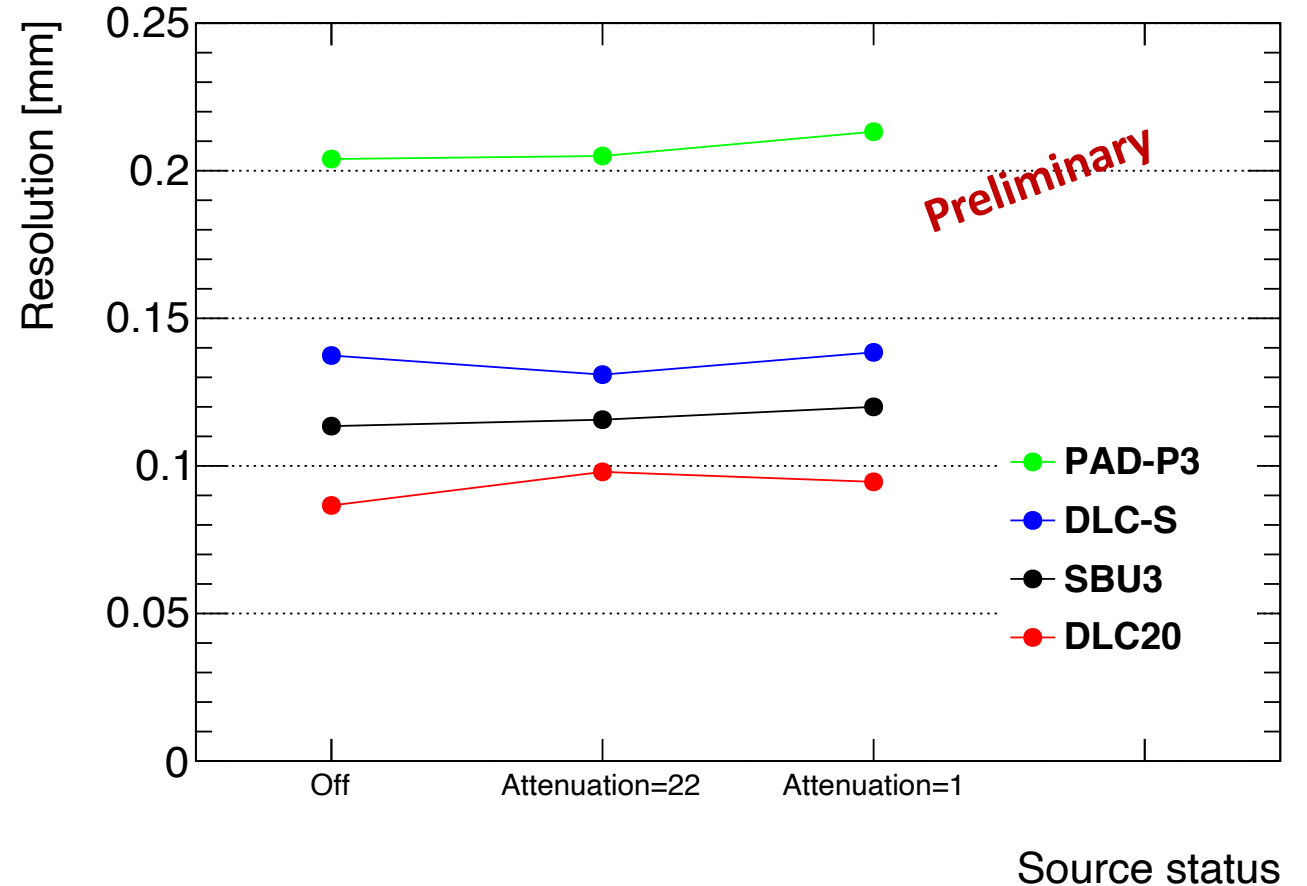


Resolution seems affected not only from the cluster size, but also from other parameters that differ among the prototypes (as resistivity and capacitive coupling of the pads). We plan to investigate the impact of the possible contributions as direct induction, capacitive coupling and resistive charge spread

# Tracking performance under gamma irradiation

Test beam at GIF++ @CERN:

- High energy muon beam in high photon background produced from an intense source of  $^{137}\text{Cs}$  (662 keV photons), intensity adjustable through attenuators
- A preliminary estimate of the counting rate in our detector position was of tens kHz/cm<sup>2</sup> at full intensity (Attenuation=1)
- Planning for another test beam period to take data closer to the source

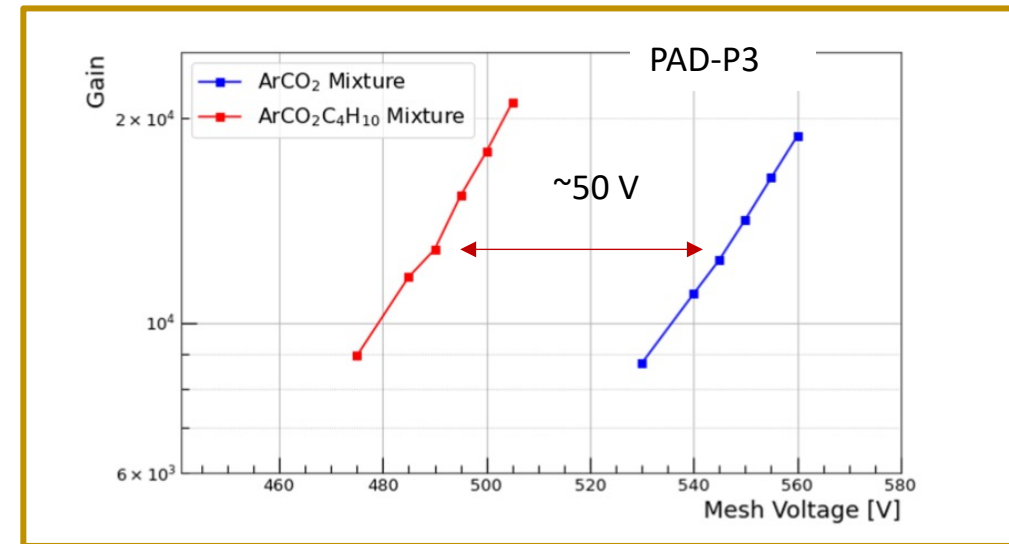
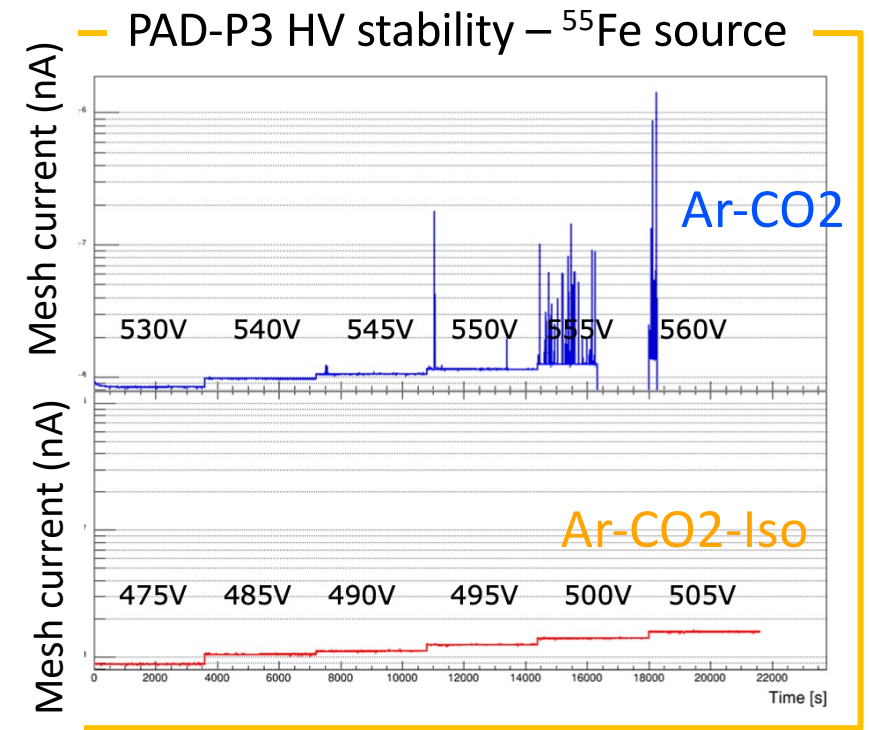
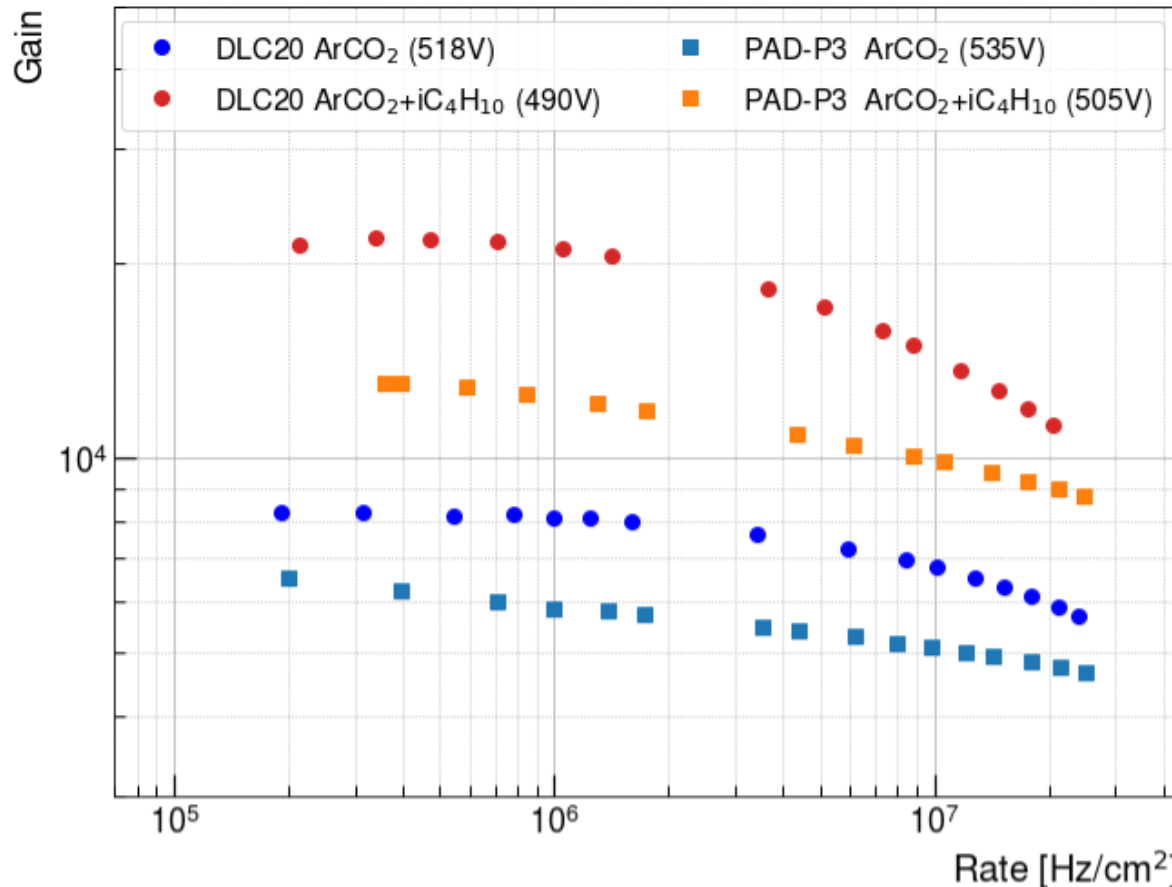


# Gas Mixture studies

With Ar:CO<sub>2</sub>=93:7 gas mixture used so far, detectors showed some current instability at high gain values

Adding 2% isobutane to the mixture (Ar:CO<sub>2</sub>:iC<sub>4</sub>H<sub>10</sub>=93:5:2) avoided sparks

Stable conditions reached at gain >10k also under very high X-Rays irradiation rates (>10 MHz/cm<sup>2</sup>)

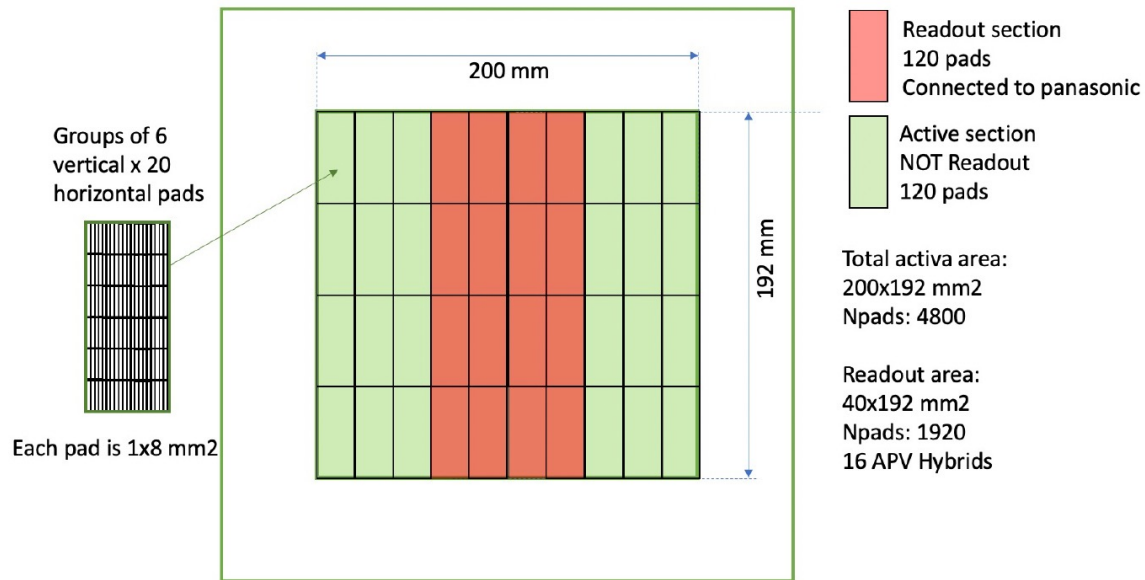


~50V difference between the two mixtures for a given gain

# Next steps

## Larger surface prototype

A larger area (20 x 20 cm<sup>2</sup>) detector is under construction:

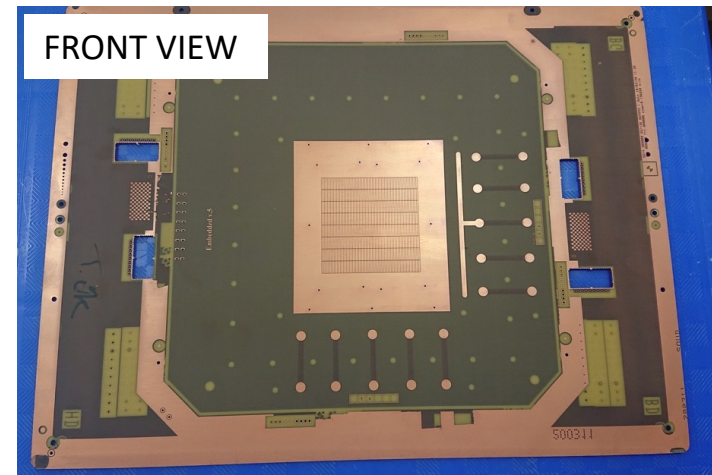


Active area: 200x192 mm<sup>2</sup>

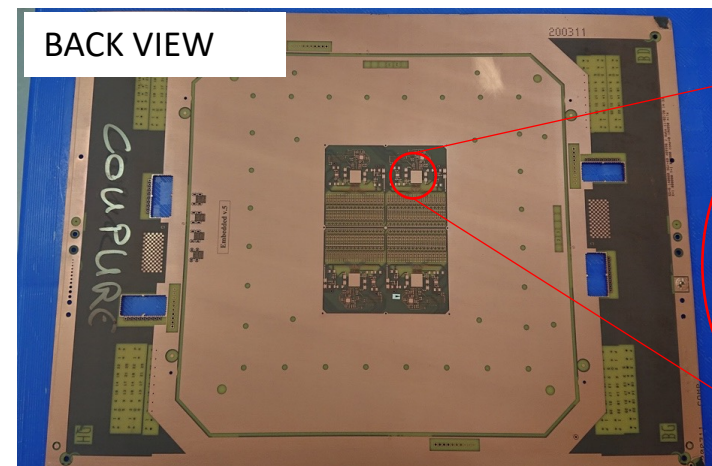
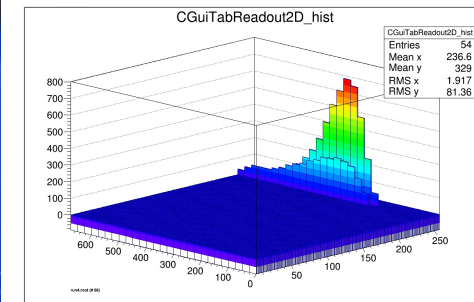
- Pads 1x8 mm<sup>2</sup> - Total Number of Pads: 4800
- Double layer DLC with grounding vias every 8 mm
- Panasonic connectors on the back of the detector
- Partially readout: 1920 connected pads out of 4800 tot pads

## EMBEDDED (back wire-bonded) electronics

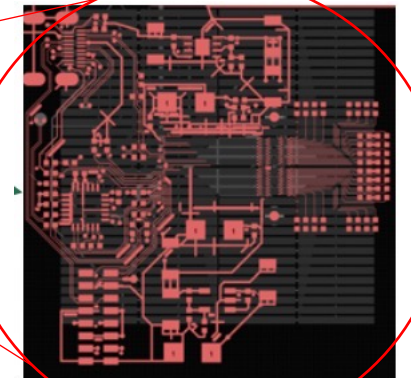
Scaling to larger surfaces only possible with electronics integrated on the back-end of the anode PCB (work in progress)



small prototype (64 x 64 mm<sup>2</sup>) built and read through APV25 FE chip



APV25 layout



# Conclusions

Different spark protection resistive layouts have been implemented on several Small Pads Micromegas prototypes. From tests and comparison among them we reached:

- stable operation up to 20 MHz/cm<sup>2</sup> with gain >10k
- detector efficiency > 97%
- position resolution < 100 μm

## Ongoing/future work:

- continue the optimization of resistive layout and gas mixture choice finalized to the tracking in high rate environment
- address the detector scalability to larger area
- measure the time resolution
- perform ageing studies